

## **MOSFET**

## OptiMOS™ 6 Power-Transistor, 100 V

## **Features**

- N-channel, normal level
- Very low on-resistance R<sub>DS(on)</sub>
- Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
   Very low reverse recovery charge (Q<sub>rr</sub>)
- · High avalanche energy rating
- 175°C operating temperature
- Optimized for high frequency switching and synchronous rectification
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020

## **Product validation**

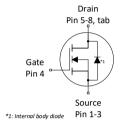
Fully qualified according to JEDEC for Industrial Applications

Table 1 Key performance parameters

Parameter	Value	Unit
$V_{\mathrm{DS}}$	100	V
R <sub>DS(on),max</sub>	8.05	mΩ
$I_{D}$	75	А
$Q_{\rm oss}$	35	nC
Q <sub>G</sub> (0V10V)	19	nC
Q <sub>rr</sub> (100A/μs)	31	nC









Type / Ordering code	Package	Marking	Related links
ISC080N10NM6	PG-TDSON-8	080N10N6	-

## Public

# OptiMOS™ 6 Power-Transistor, 100 V ISC080N10NM6



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# 1 Maximum ratings

at  $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			11	Note / Test condition
Parameter	Symbol	Min.	Тур.	Max.	Onic	Note / Test condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	75 53 48 13	А	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =50°C/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	300	А	T <sub>A</sub> =25 °C
Avalanche current, single pulse <sup>4)</sup>	I <sub>AS</sub>	-	-	50	Α	<i>T</i> <sub>C</sub> =25 °C
Avalanche energy, single pulse	E <sub>AS</sub>	-	-	185	mJ	$I_{\rm D}$ =11 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	$V_{GS}$	-20	-	20	V	-
Power dissipation	$P_{tot}$	_	-	100 3.0	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W <sup>2)</sup>
Operating and storage temperature	$T_{\rm j}, T_{\rm stg}$	-55	-	175	°C	-

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

## 2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
raiailletei	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition
Thermal resistance, junction - case, bottom	$R_{thJC}$	-	0.77	1.5	°C/W	
Thermal resistance, junction - case, top	$R_{thJC}$	-	-	20	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area	$R_{thJA}$	-	-	50	°C/W	

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^2$  (one layer, 70  $\mu$ m thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information



## 3 Electrical characteristics

at  $T_i$ =25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Linit	Note / Test condition	
Parameter	Syllibol	Min.	Тур.	Max.		Note / Test condition	
Drain-source breakdown voltage	$V_{(BR)DSS}$	100	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2.3	2.8	3.3	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 36 \mu{\rm A}$	
Zero gate voltage drain current	ro gate voltage drain current $I_{loc}$ $I$ - $I$		1.0 100	μΑ	$V_{\rm DS}$ =80 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =80 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C <sup>5)</sup>		
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	$V_{\rm GS}$ =20 V, $V_{\rm DS}$ =0 V	
Drain-source on-state resistance	ource on-state resistance $R_{\rm DS(on)}$ - $\begin{bmatrix} 7.1 & 8.05 \\ 8.7 & 10 \end{bmatrix}$			mΩ	$V_{GS}$ =10 V, $I_{D}$ =20 A $V_{GS}$ =8 V, $I_{D}$ =10 A		
Gate resistance	$R_{G}$	0.6	1.2	1.8	Ω	-	
Transconductance	$g_{fs}$	15	30	_	S	$ V_{\rm DS}  \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D}=20 \text{ A}$	

<sup>&</sup>lt;sup>5)</sup> Defined by design. Not subject to production test.

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Linit	Note / Test condition
	Symbol	Min.	Тур.	Max.	Ollic	Note / Test condition
Input capacitance	C <sub>iss</sub>	-	1400	1800	pF	
Output capacitance <sup>6)</sup>	Coss	-	310	390	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, <i>f</i> =1 MHz
Reverse transfer capacitance <sup>6)</sup>	C <sub>rss</sub>	-	9	13	pF	
Turn-on delay time	t <sub>d(on)</sub>	-	6.4	-	ns	
Rise time	t <sub>r</sub>	-	1.5	-	ns	$V_{DD}$ =50 V, $V_{GS}$ =10 V, $I_{D}$ =10 A,
Turn-off delay time	$t_{\sf d(off)}$	-	10.7	-	ns	$R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	$t_{\rm f}$	-	4.3	-	ns	

<sup>&</sup>lt;sup>6)</sup> Defined by design. Not subject to production test.



Table 6 Gate charge characteristics 7)

Parameter	Symbol	Values			Linit	Note / Test condition	
raiailietei	Symbol	Min.	Тур.	Max.	Oilit	Note / Test condition	
Gate to source charge <sup>8)</sup>	$Q_{\rm gs}$	-	6.4	8.5	nC		
Gate charge at threshold <sup>8)</sup>	$Q_{g(th)}$	-	3.9	4.9	nC		
Gate to drain charge <sup>8)</sup>	$Q_{gd}$	-	3.4	5.1	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =10 A, $V_{\rm GS}$ =0 to 10 V	
Switching charge	$Q_{sw}$	-	5.9	-	nC	DD 30 V, D 10 M, V <sub>GS</sub> 0 to 10 V	
Gate charge total <sup>8)</sup>	$Q_{\mathrm{g}}$	-	19	24	nC		
Gate plateau voltage	$V_{ m plateau}$	-	4.6	-	V		
Gate charge total, sync. FET	$Q_{\rm g(sync)}$	-	17	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V	
Output charge <sup>8)</sup>	Qoss	-	35	44	nC	V <sub>DS</sub> =50 V, V <sub>GS</sub> =0 V	

<sup>7)</sup> See "Gate charge waveforms" for parameter definition

## Table 7 Reverse diode

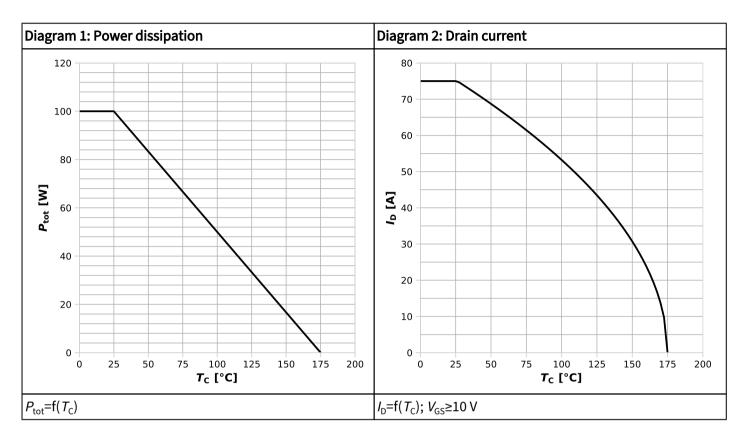
Parameter	Symbol	Values			Linit	Note / Test condition	
	Syllibot	Min.	Тур.	Max.		Note / Test condition	
Diode continuous forward current	Is	-	-	75	А	<i>T<sub>c</sub></i> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	300	Α	1 <sub>C</sub> -25 C	
Diode forward voltage	$V_{SD}$	-	0.82	1.0	V	$V_{\rm GS}$ =0 V, $I_{\rm F}$ =20 A, $T_{\rm j}$ =25 °C	
Reverse recovery time <sup>9)</sup>	t <sub>rr</sub>	-	31.5	47	ns	$V_{\rm R}$ =50 V, $I_{\rm F}$ =10 A, d $i_{\rm F}$ /d $t$ =100 A/ $\mu$ s	
Reverse recovery charge <sup>9)</sup>	$Q_{\rm rr}$	-	31	46.5	nC		
Reverse recovery time <sup>9)</sup>	$t_{\rm rr}$	_	18	27	ns	$V_{\rm R}$ =50 V, $I_{\rm F}$ =10 A, d $i_{\rm F}$ /d $t$ =1000 A/ $\mu$ s	
Reverse recovery charge <sup>9)</sup>	$Q_{\rm rr}$	_	140	210	nC		

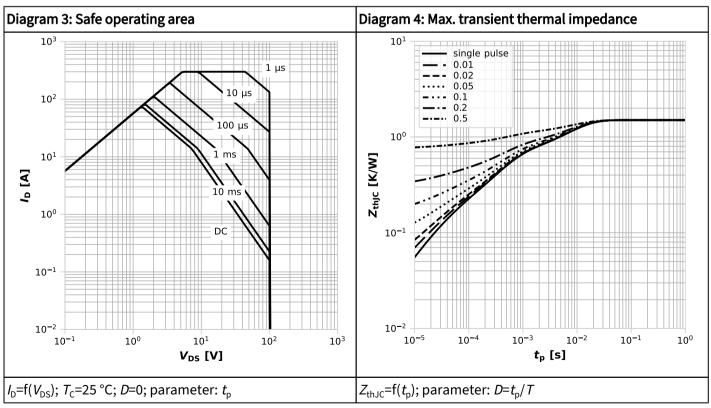
<sup>9)</sup> Defined by design. Not subject to production test.

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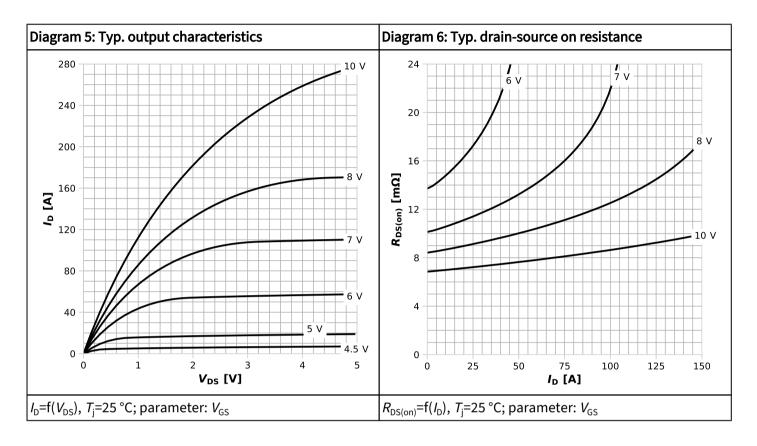


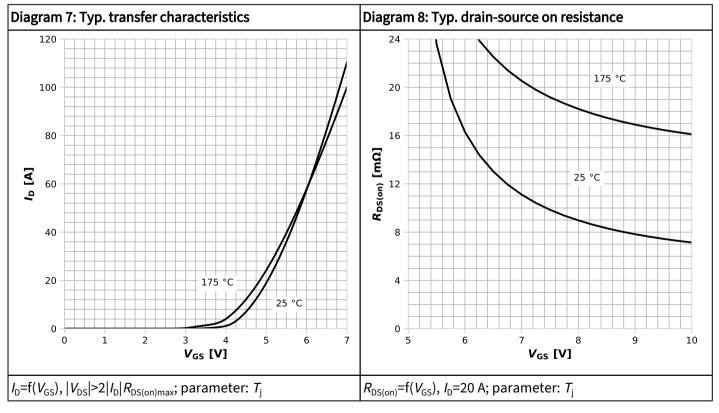
# 4 Electrical characteristics diagrams



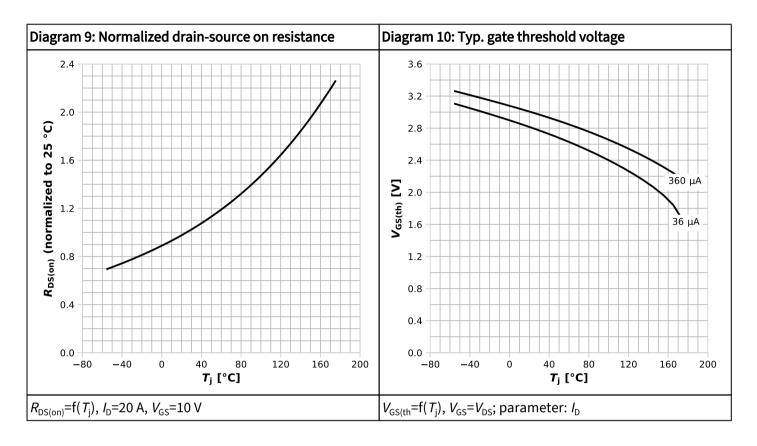


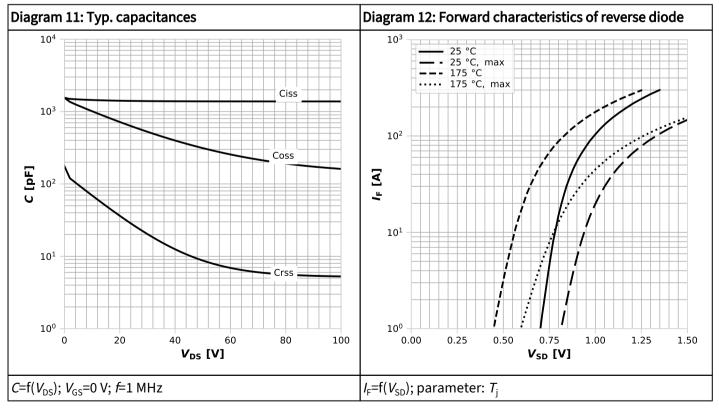




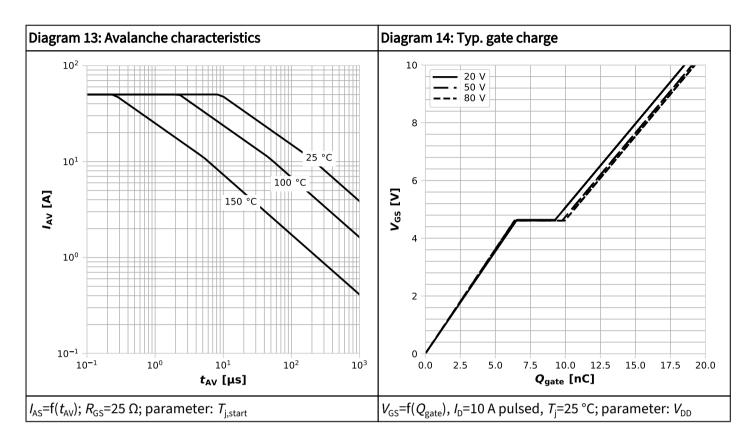


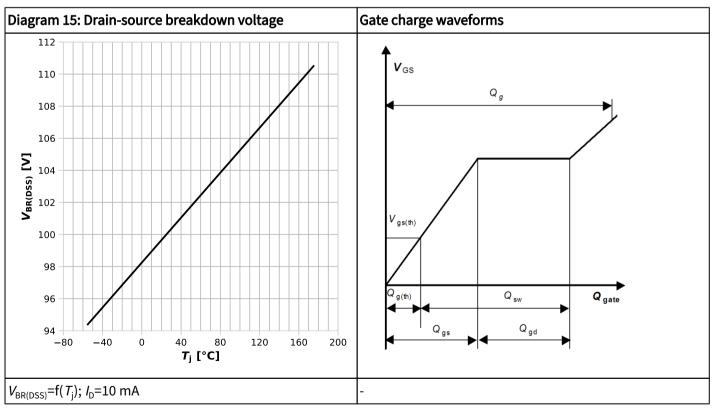














# 5 Package outlines

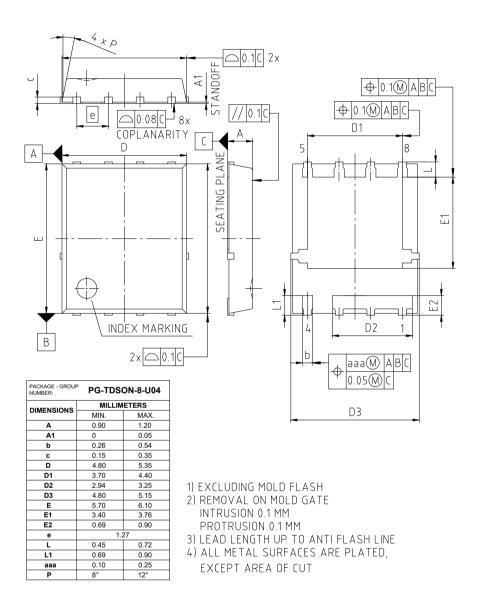


Figure 1 Outline PG-TDSON-8, dimensions in mm



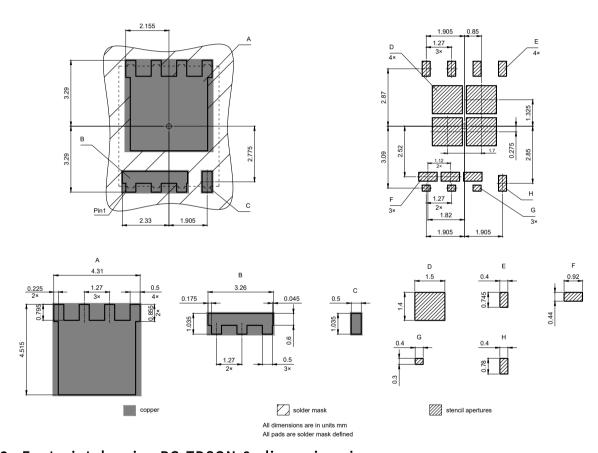


Figure 2 Footprint drawing PG-TDSON-8, dimensions in mm



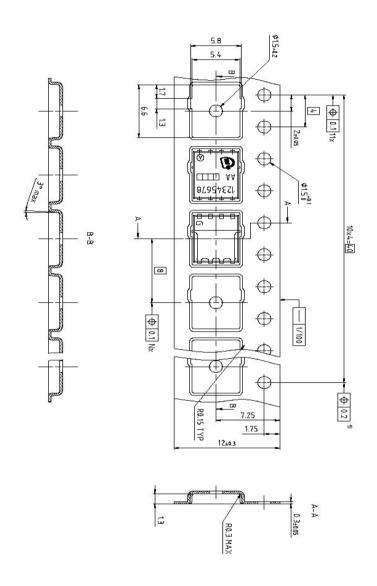


Figure 3 Packaging variant PG-TDSON-8, dimensions in mm



## **Revision history**

ISC080N10NM6

#### Revision 2024-12-16, Rev. 2.3

#### Previous revisions

Revision	Date	Subjects (major changes since last revision)
2.0	2021-07-05	Release of final version
2.1	2021-07-20	Update IAS
2.2	2023-02-07	Update SOA Diagram
2.3	2024-12-16	Update IAS

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